

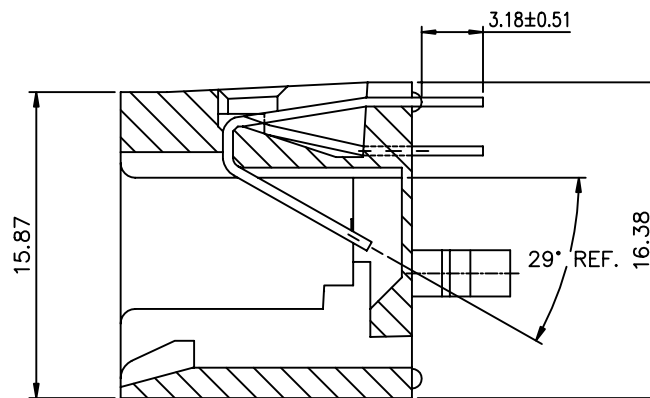
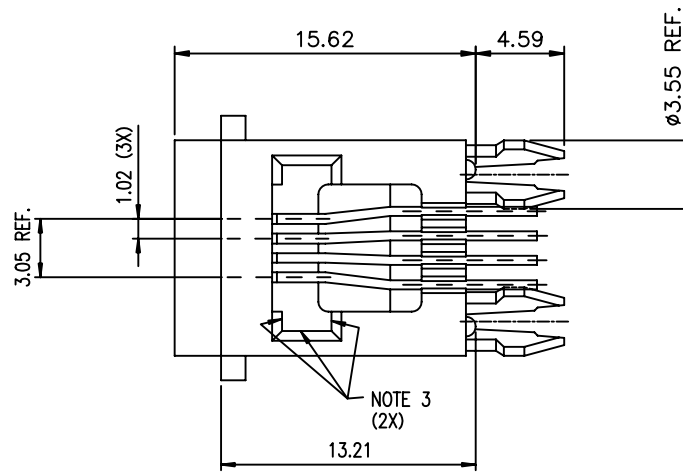
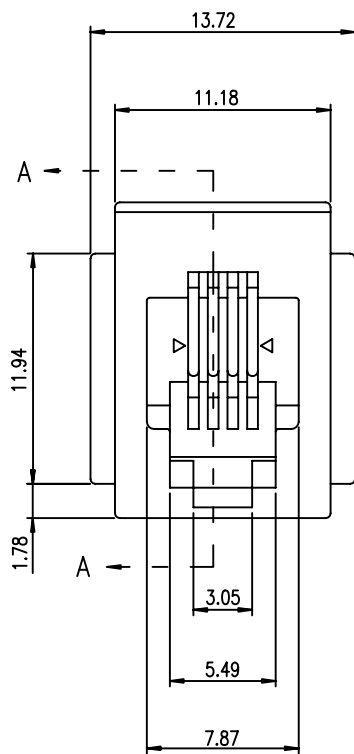
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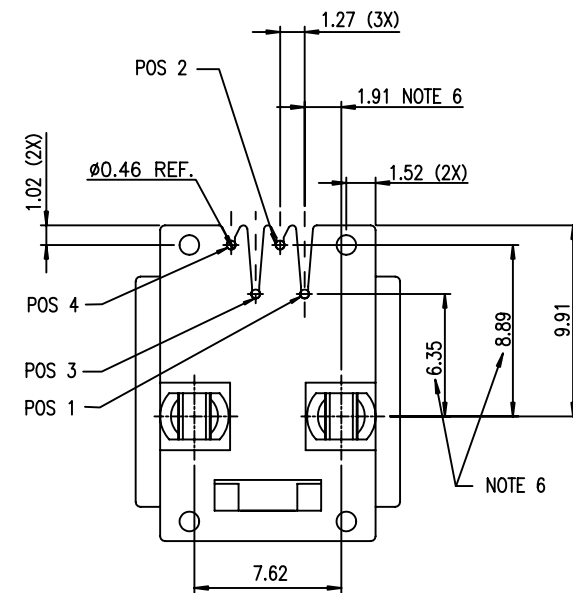
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PRODUCT NO.

SEE TABLE



SECTION A-A



mat'l code				tolerance unless otherwise specified			CUSTOMER		FCI		www.fciconnect.com	
rev.	ecn	no.	dr	date	linear	.0 ± 0.25	projection		title 4 POS VERT. SPECIAL PEG P.C.B. III MOD JACK ASSY			
A	T80030	CAWY L	01/21/98	.00 ± 0.13								
B	T90021	M W	01/19/99	.000± 0.05								
C	N10059	WL	05/22/01		angles	± 2°						
D	N04-0023	D QIN	06/07/04		dr	C L FENG	02/21/97	unit	product family MOD JACK		code	
E	N04-0102	YS	11/23/04		enr	TONY CHIEN	02/21/97	mm/inch	size		dwg no.	
F	N04-0109	YS	11/30/04		chr	TONY CHIEN	02/21/97	scale	A3		61835	
G	N08-0097	SH	09/24/08		appd	JENN TSAO	02/21/97			sheet 1 OF 2		
sheet	revision	G	G									
index	sheet	1	2									

PDM: Rev:G

STATUS: Released

Printed: Oct 09, 2008

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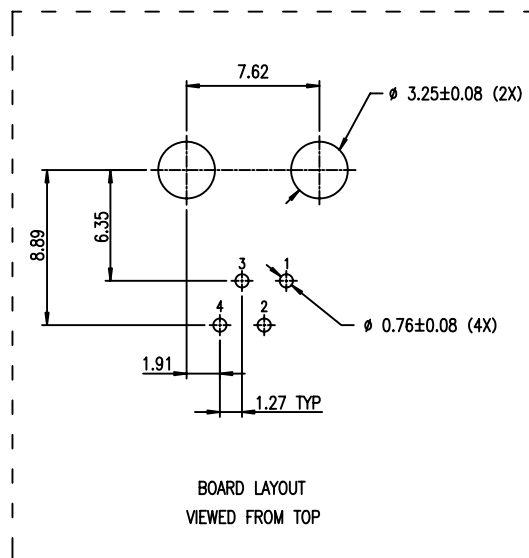
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PRODUCT NO.	NO. OF POS	LOADED POS	HSG COLOR
61835-X441	4	ALL POS	BLACK
-X421	4	3,4	BLACK
-X442	4	ALL POS	GRAY
-X422	4	3,4	GRAY

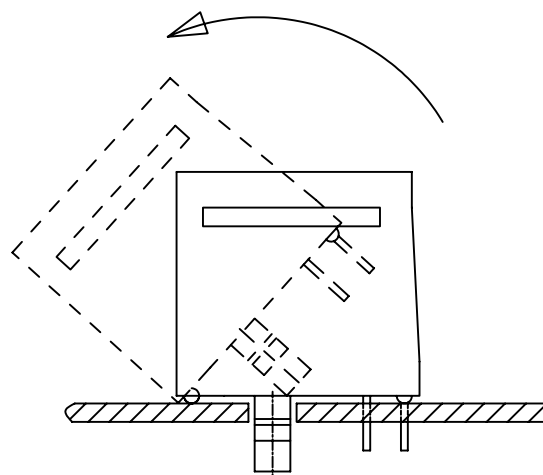
PLATING CODE X	PLATING
0	30 μ " G.X.T.
1	15 μ " GOLD
3	30 μ " GOLD
4	6 μ " GOLD
5	50 μ " GOLD

10

10



DIRECTION OF DISMOUNT



JACK DISMOUNT METHOD

DETAIL A
NOTE 5

NOTES:

- P/N WITH DASH X4XX -NORMAL WAVE SOLDERING APPLICATION.
- PACKAGING SPEC. GES-14-351. (USING TRAY).
- SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- JACK IS FOR 1.57/.062 THICK PCB.
- SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB. PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- THESE DIMENSIONS ARE MEASURED FROM THE TOP OF THE PEG.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- IF LF P/N PACKSGING MEETS GS-14-920 SPECIFICATION
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57mm MINIMUM THICK CIRCUIT BOARD
- 10 EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR .

mat'l code					tolerance unless otherwise specified		CUSTOMER COPY				www.fciconnect.com			
rev.	ecn	no.	dr	date	linear	.0 ± 0.25		projection 	title 4 POS VERT. SPECIAL PEG P.C.B. III MOD JACK ASSY					
G						.00 ± 0.13								
						.000± 0.05								
					angles	± 2°			product family MOD JACK				code TWN	
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					enr	TONY CHIEN 02/20/97								
					chr	TONY CHIEN 02/20/97								
					appd	JENN TSAO 02/20/97								
sheet		revision							size		dwg no.		sheet 2 OF	
index		sheet							A3		61835			